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4A, 100V - 200V Ultra Fast Surface Mount Rectifier

FEATURES

- Planar technology
- Low power loss, high efficiency
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- High frequency switching
- DC/DC
- Snubber

MECHANICAL DATA

- Case: DO-214AA (SMB)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.088g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I _F	4	А	
V _{RRM}	100 - 200	V	
I _{FSM}	130	А	
T _{J MAX}	175	°C	
Package	DO-214AA (SMB)		
Configuration	Single die		







DO-214AA (SMB)



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)					
PARAMETER		SYMBOL	PU4BB	PU4DB	UNIT
Marking code on the device			PU4BB	PU4DB	
Repetitive peak reverse voltage		V _{RRM}	100	200	V
Reverse voltage, total rms value		V _{R(RMS)}	70	140	V
Forward current		١ _F	4		А
Surge peak forward current single half	t = 8.3ms		130		Α
sine-wave superimposed on rated load	t = 1.0ms	I _{FSM}	290		A
Junction temperature		TJ	-55 to +175		°C
Storage temperature		T _{STG}	-55 to +175		°C



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THERMAL PERFORMANCE			
PARAMETER	SYMBOL	ТҮР	UNIT
Junction-to-lead thermal resistance	R _{ƏJL}	13	°C/W
Junction-to-ambient thermal resistance	R _{ØJA}	69	°C/W
Junction-to-case thermal resistance	R _{eJC}	17	°C/W

Thermal Performance Note: Units mounted on PCB (10mm x 10mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^{\circ}C$ unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
	$I_F = 2A, T_J = 25^{\circ}C$		0.79	-	V
Forward voltage ⁽¹⁾	$I_{F} = 4A, T_{J} = 25^{\circ}C$	N	0.84	0.93	V
Forward voltage	$I_F = 2A, T_J = 125^{\circ}C$	V _F	0.64	-	V
	$I_F = 4A, T_J = 125^{\circ}C$		0.70	-	V
Reverse current @ rated $V_R^{(2)}$	$T_J = 25^{\circ}C$	- I _R	-	2	μA
	T _J = 125°C		-	10	μA
Junction capacitance	$1MHz, V_R = 4.0V$	CJ	78	-	pF
	$I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A$		-	25	ns
Reverse recovery time	$I_F = 1.0A$, di/dt = 50A/µs, $V_R = 30V$	t _{rr}	31	-	
Reverse recovery current		I _{RM}	4.9	-	А
Reverse recovery charge	$I_F = 4.0A$, di/dt = 200A/µs, $V_R = 100V$	Q _{rr}	57	-	nC
Reverse recovery time		t _{rr}	24	-	ns

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION		
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING
PU4xB	DO-214AA (SMB)	3,000/ Tape & Reel

Notes:

1. "x" defines voltage from 100V(PU4BB) to 200V(PU4DB)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

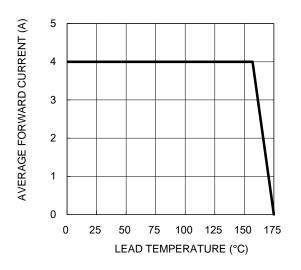
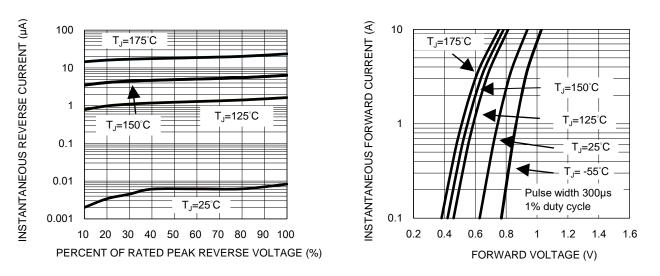


Fig.1 Forward Current Derating Curve

Fig.3 Typical Reverse Characteristics

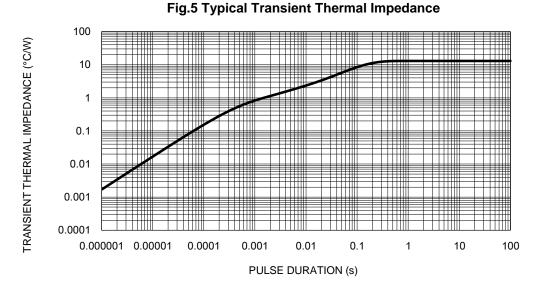


CAPACITANCE (pF)

100

10

1



1000

10

Fig.4 Typical Forward Characteristics

REVERSE VOLTAGE (V)

100

f=1.0MHz Vsig=50mVp-p

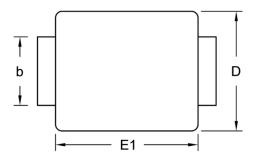
Fig.2 Typical Junction Capacitance

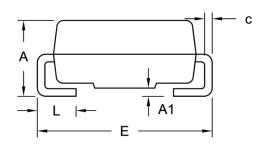
PU4BB – PU4DB Taiwan Semiconductor



PACKAGE OUTLINE DIMENSIONS

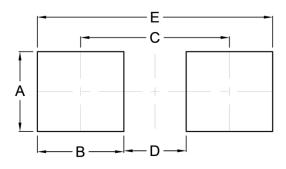
DO-214AA (SMB)





DIM.	Unit (mm)		Unit	(inch)	
	Min.	Max.	Min.	Max.	
A	1.95	2.65	0.077	0.104	
A1	0.05	0.20	0.002	0.008	
b	1.95	2.20	0.077	0.087	
с	0.15	0.31	0.006	0.012	
D	3.30	3.95	0.130	0.156	
E	5.10	5.60	0.201	0.220	
E1	4.05	4.60	0.159	0.181	
L	0.75	1.60	0.030	0.063	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	2.30	0.091
В	2.50	0.098
С	4.30	0.169
D	1.80	0.071
E	6.80	0.268

MARKING DIAGRAM



P/N	= Marking Code
G	= Green Compound

YW = Date Code

F = Factory Code



PU4BB – PU4DB

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